



AH3368Q

HIGH VOLTGAE LOW SENSITIVITY AUTOMOTIVE HALL EFFECT UNIPOLAR SWITCH

Description

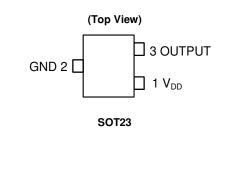
The AH3368Q is an AECQ100 qualified high voltage low sensitivity Hall Effect Unipolar switch IC designed for position and proximity sensing in automotive applications such as in seat and seatbelt buckle, steering lock/immobilisation, gear stick, transmission actuator and gear position, HVAC compression, wiper, door/trunk closure, etc. To support wide range of demanding applications, the design has been optimized to operate over the supply range of 3.0V to 28V. With chopper stabilized architecture and an internal bandgap regulator to provide temperature compensated supply for internal circuits, the AH3368Q provides a reliable solution over the whole operating range. For robustness and protection, the device has a reverse blocking diode with a Zener clamp on the supply. The output has an over current limit and a Zener clamp.

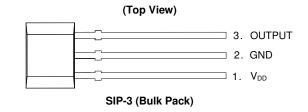
The single open drain output can be switched on with South pole of sufficient strength. When the magnetic flux density (B) perpendicular to the package is larger than the operate point (B_{OP}) the output is switched on (pulled low) and is held on until magnetic flux density B is lower than the release point (B_{RP}). The output remains switched off for North pole fields to or no magnetic fields.

Features

- Unipolar Operation
- Low Sensitivity: B_{OP} and B_{RP} of 150G and 125G Typical
- Single Open Drain Output with Over Current Limit
- 3.0V to 28V Operating Voltage RP0ange
- Chopper Stabilized Design Provides
 - Superior Temperature Stability
 - Minimal Switch Point Drift
 - Enhanced Immunity to Stress
- Good RF Noise Immunity
- Reverse Blocking Diode
- Zener Clamp on Supply and Output Pins
- -40°C to +150°C Operating Temperature
- ESD: HBM > 8kV, CDM: > 2kV
- AECQ100 Grade 0 Qualified
- Industry Standard SOT23 and SIP-3 (Ammo Pack), SIP-3 (Bulk Pack) Packages
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Pin Assignments





Applications

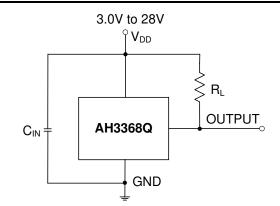
- Position and Proximity Sensing in Automotive Applications
- Seat Position
- Seatbelt Buckle
- Steering Lock/Immobilisation
- Gear Stick
- HVAC Compression
- Transmission Actuator
- Transmission Gear Position
- Wipers
- Sunroof and Windows
- Door/Trunk Closure
- Door Locks
- Contact-Less Switches

Notes:

- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- and Lead-free.
- Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Typical Applications Circuit (Note 4)



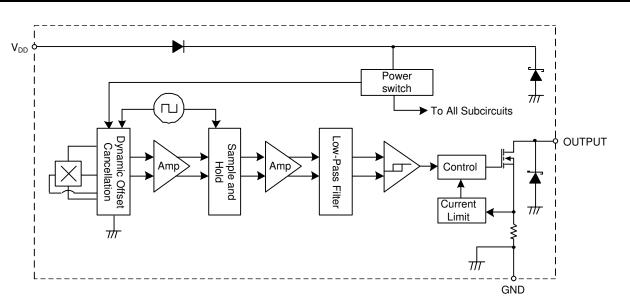
Note: 4. C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 10nF ~ 100nF. R_L is the pull-up resistor.

Pin Descriptions

Package: SOT23 and SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)

Pin Number	Pin Name	Function
1	V _{DD}	Power Supply Input
2	GND	Ground
3	OUTPUT	Output Pin

Functional Block Diagram





Absolute Maximum Ratings (Note 5 & 6) (@T_A = +25°C, unless otherwise specified.)

Symbol	Characteristic		Value	Unit
V _{DD}	Supply Voltage (Note 6)		32	V
V _{DDR}	Reverse Supply Voltage (Note 6)		-32	V
V _{OUT_MAX}	Output Off Voltage (Note 6)		32	V
I _{OUT}	Continuous Output Current		60	mA
I _{OUT_R}	Reverse Output Current		-50	mA
В	Magnetic Flux Density		Unlimited	•
PD	Package Power Dissipation	SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)	550	mW
		SOT23	230	
Ts	Storage Temperature Range		-65 to +165	°C
TJ	Maximum Junction Temperature		+150	°C
ESD HBM	Electros Static Discharge Withstand - Human Body Model (HM	IB)	8	kV
ESD MM	Electros Static Discharge Withstand - Machine Model (MM)		800	V
ESD CDM	Electros Static Discharge Withstand - Charged Device Model (CDM)	2	kV

5. Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; Notes: functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.

6. The absolute maximum V_{DD} of 32V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

Recommended Operating Conditions (@TA = -40°C to +150°C, unless otherwise specified.)

Symbol	Parameter	Condition	Rating	Unit
V _{DD}	Supply Voltage	Operating	3.0 to 28	V
TA	Operating Temperature Range	Operating	-40 to +150	°C

Electrical Characteristics (Note 7 & 8) (@T_A = -40°C to +150°C, V_{DD} = 3V to 28V, unless otherwise specified.)

Symbol	Parameter	Condition	Min	Тур	Max	Unit
V _{OUT_ON}	Output ON Voltage	I _{OUT} = 20mA, B > Bop	-	0.2	0.4	V
I _{LKG}	Output Leakage Current (When output is off)	$V_{OUT} = 28V, B < Brp, Output off$	-	<0.1	10	μA
la a	Supply Current	Output open, $T_A = +25^{\circ}C$	-	3	3.5	mA
I _{DD}	Supply Current	Output open, T _A = -40°C to +150°C	-	-	4	mA
		$V_{DD} = -18V, T_A = +25^{\circ}C$	-	0.6	-	μΑ
I _{DD R}	Reverse Supply Current	$V_{DD} = -18V$, $T_A = -40^{\circ}C$ to $+150^{\circ}C$	-	0.6	1500	μΑ
י_עעי	Reverse Supply Current	$V_{DD} = -28V, T_A = +25^{\circ}C$	-	1.6	-	μΑ
		$V_{DD} = -28V$, $T_A = -40^{\circ}C$ to $+150^{\circ}C$	-	1.6	2500	μΑ
tp on	Device Power-On Time (Start-up time)	$V_{DD} \ge 3V, B \ge Bop (Note 7)$	-	10	-	μs
fc	Chopping Frequency	-	-	800	-	kHz
t _D	Response Time Delay (Time from magnetic threshold reached to the start of the output rise or fall)	(Note 9)	-	3.75	-	μs
t _R	Output Rising Time (External pull-up resistor RL and load capacitance dependent)	$R_L = 1k\Omega, C_L = 20pF$	-	0.2	1	μs
t _F	Output Falling Time (Internal switch resistance and load capacitance dependent)	$R_L = 1k\Omega, C_L = 20pF$	-	0.1	1	μs
IOCL	Output Current Limit	B > Bop, (Note 10)	30	-	55	mA
Vz	Zener Clamp Voltage	I _{DD} = 5mA	28	-	-	V

7. When power is initially turned on, Vob must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid Notes: after the start-up time of 10µs typical from the operating voltage reaching 3V.

8. Typical values are defined at T_A = +25°C, V_{DD} = 12V. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization.

9. Guaranteed by design, process control and characterization. Not tested in production.

10. The device will limit the output current I_{OUT} to current limit of I_{OCL}



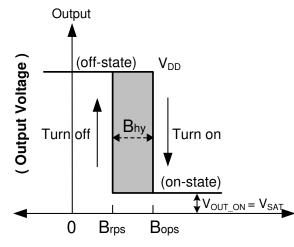
Magnetic Characteristics (Note 11 &12) (T_A = -40°C to +150°C, V_{DD} = 3.0V to 28V, unless otherwise specified.)

				(1mT=10 (Gauss)
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
B _{OPS} (South pole to the part marking		$V_{DD} = 12V, T_A = +25^{\circ}C$	-	150	-	
side of SOT23 and SIP-3 (Ammo Pack), SIP-3 (Bulk Pack) packages)	Operation Point	$T_{A} = -40^{\circ}C \text{ to } +150^{\circ}C$	130	150	180	
B _{RPS} (South pole to the part marking		$V_{DD} = 12V, T_A = +25^{\circ}C$	-	125	-	Gauss
side of SOT23 and SIP-3 (Ammo Pack), SIP-3 (Bulk Pack) packages)	Release Point	$T_{A} = -40^{\circ}C \text{ to } +150^{\circ}C$	105	125	160	Gauss
	Hysteresis (Note 13)	$V_{DD} = 12V, T_A = +25^{\circ}C$	-	25	-]
Bhy (Bopx - Brpx)	Hysteresis (Note 13)	$T_{A} = -40^{\circ}C \text{ to } +150^{\circ}C$	16	25	33	

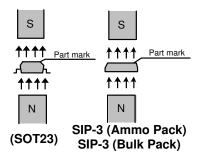
Notes: 11. When power is initially turned on, V_{DD} must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10µs typical from the operating voltage reaching 3V.

12. Typical values are defined at T_A = +25°C, V_{DD} = 12V. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization.

13. Maximum and minimum hysteresis is guaranteed by design, process control and characterization.



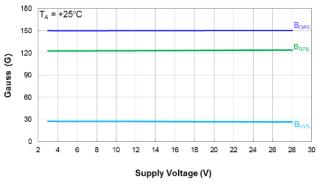
(Magnetic Flux Density B)



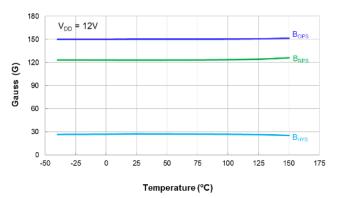


Typical Operating Characteristics

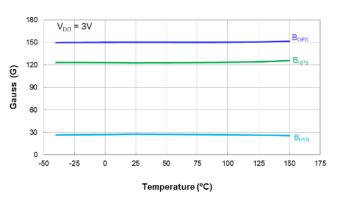
Output Switch Operate and Release Points (Magnetic Thresholds) – BOPS and BRPS



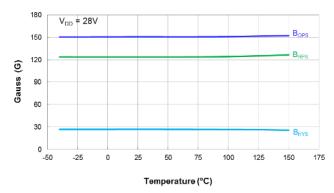
Switch Points B_{OPS} and B_{RPS} vs Supply Voltage



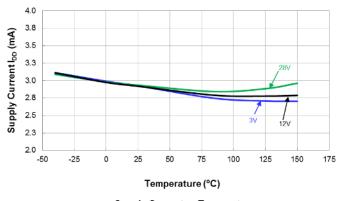
Switch Points B_{OPS} and B_{RPS} vs Temperature



Switch Points $\mathbf{B}_{\mathsf{OPS}}$ and $\mathbf{B}_{\mathsf{RPS}}$ vs Temperature

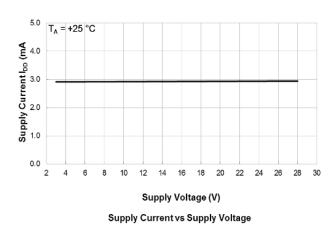


Switch Points B_{OPS} and B_{RPS} vs Temperature



Supply Current vs Temperature

Supply Current





28

241

125

150

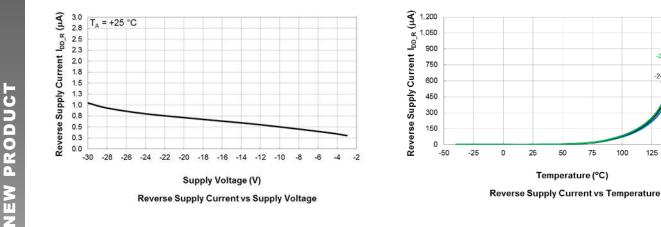
175

100

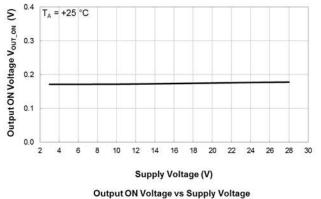
75

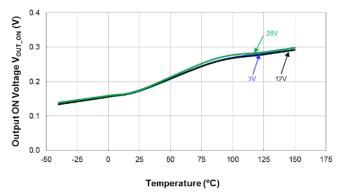
Typical Operating Characteristics (Cont.)

Supply Reverse Current

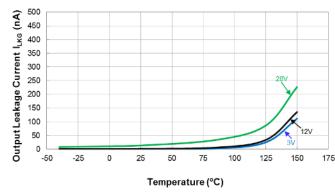


Output Switch On Voltage



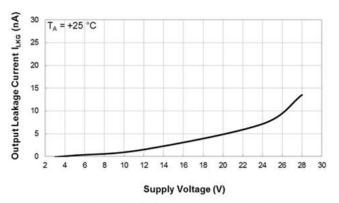


Output ON Voltage vs Temperature



Output Leakage Current vs Temperature

Output Switch Leakage Current

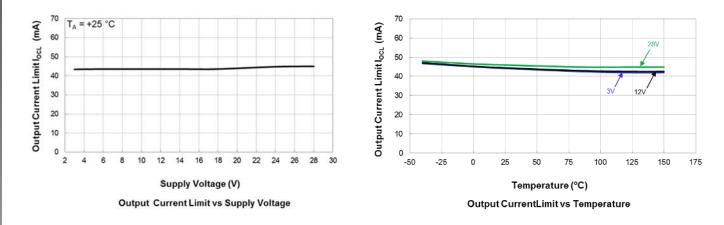


Output Leakage Current vs Supply Voltage



Typical Operating Characteristics (Cont.)

Output Current Limit

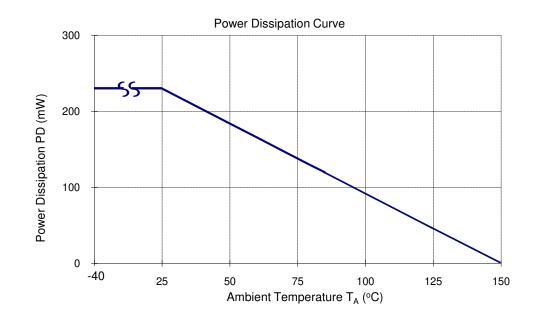




Thermal Performance Characteristics

(1) Package type: SOT23

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	230	184	166	147	129	120	110	92	83	74	55	46	37	18	0

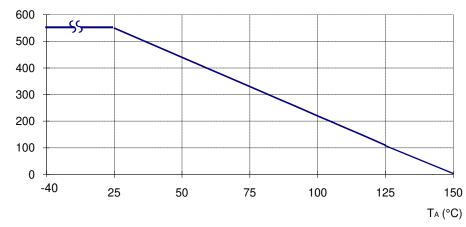


(2) Package type: SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	550	440	396	362	308	286	264	220	198	176	132	110	88	44	0

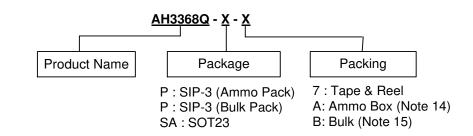
P_D (mW)

Power Dissipation Curve





Ordering Information

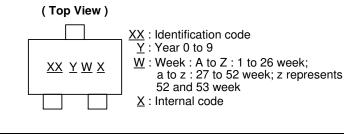


	Dookogo		Bul	k Box	7" Tape an	d Reel	Amm	io Box
Part Number	Package Code	Packaging	Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH3368Q-P-A	Р	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH3368Q-P-B	Р	SIP-3 (Bulk Pack)	1000	-В	NA	NA	NA	NA
AH3368Q-SA-7	SA	SOT23	NA	NA	3000/Tape & Reel	-7	NA	NA

Notes: 14. Ammo Box is for SIP-3 (Ammo Pack) Spread Lead. 15. Bulk is for SIP-3 (Bulk Pack) Straight Lead.

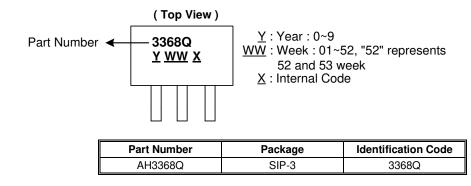
Marking Information

(1) Package Type: SOT23



Part Number	Package	Identification Code		
AH3368Q	SOT23	MM		

(2) Package Type: SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)

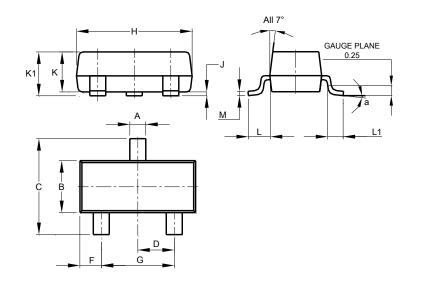




Package Outline Dimensions (All dimensions in mm.)

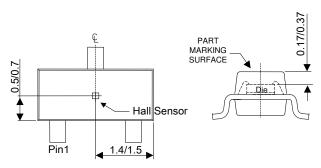
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SOT23



	SO	Г23	
Dim	Min	Max	Тур
Α	0.37	0.51	0.40
В	1.20	1.40	1.30
С	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
Н	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
М	0.085	0.150	0.110
а	0°	8°	
All [Dimensi	ions in I	mm

Min/Max

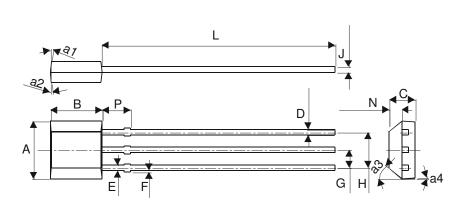


Sensor Location



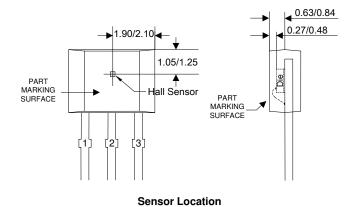
Package Outline Dimensions (Cont.) (All dimensions in mm.)

(2) Package Type: SIP-3 (Bulk Pack)



SIP	-3 (Bulk	Pack)
Dim	Min	Max
Α	3.9	4.3
a1	5°	Тур
a2	5°	Тур
a3	45°	[,] Тур
a4	3°	Тур
В	2.8	3.2
С	1.40	1.60
D	0.33	0.432
Е	0.40	0.508
F	0	0.2
G	1.24	1.30
Н	2.51	2.57
J	0.35	0.43
L	14.0	15.0
Ν	0.63	0.84
Р	1.55	-
All Di	mension	s in mm

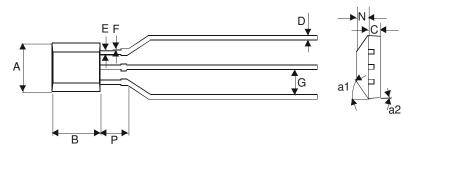
Min/Max





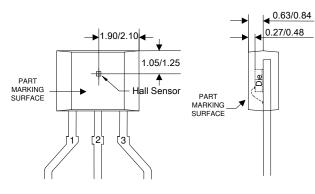
Package Outline Dimensions (Cont.) (All dimensions in mm.)

(3) Package Type: SIP-3 (Ammo Pack)



SIP-	3 (Amm	o Pack)
Dim	Min	Max
Α	3.9	4.3
a1	45	5° Тур
a2	3	° Тур
В	2.8	3.2
С	1.40	1.60
D	0.35	0.41
Е	0.43	0.48
F	0	0.2
G	2.4	2.9
Ν	0.63	0.84
Р	1.55	-
All Di	mensio	ns in mm

Min/Max



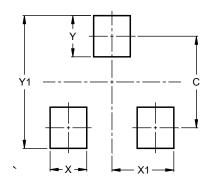
Sensor Location



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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